Engineering Design Team (EDT) - Certificate of Volatility							
Model: PCI CDa (all variations & revisions)	Part Number: 019-01854, 019-01960, 019-02039, 019-02216, 019-02219, 019-02234, 019-11854, 019-12219, 019-14879			Address: Engineering Design Team, Inc. 3423 NE John Olsen Avenue Hillsboro, OR 97124 U.S.A. +1-503-690-1234 or 1-800-435-4320			
	<u> </u>	V	olatile Memory	71 000 000 120 121 121 121			
Does the device contain volatile memory (memory whose contents are lost when power is removed)?							
Yes No If yes, describe the type, size, function, and steps to clear the memory below							
Type (SRAM, DRAM, etc): FPGA: Xilinx XC2S200- 6FG456C	Size: 5292 logic cells. 56Kbit Block RAM.	User Modifiable: ☐ Yes ☑ No	Function: DMA logic, RAM used as FIFOs for buffering. Commonly referred to as the "PCI FPGA".	Steps to clear memory: Power down			
Type (SRAM, DRAM, etc): FPGA: Xilinx XC2S300E- 6FG456C or XC2S600E- 6FGG456C	Size: 6912 or 15552 logic cells. 64K or 288K bits Block RAM.	User Modifiable:	Function: Data processing logic. Commonly referred to as the "UI FPGA".	Steps to clear memory: Power down			
Type (SRAM, DRAM, etc): SRAM: IDT 71V65603S100PFG	Size: 9Mbit	User Modifiable: ☐ Yes ☑ No	Function:	Steps to clear memory: Power down			
		Non	-Volatile Memory				
Does the device contain non-volatile memory (memory whose contents are retained when power is removed)?							
			os to clear the memory below	Io.			
Type (Flash, EEPROM, etc): CPLD: Xilinx XC9572XL- 10VQG64C	Size: 72 macrocell s	User Modifiable: ☐ Yes ☑ No	Function: Configuration control: configures the "PCI FPGA" from flash on board power up	Steps to clear memory: JTAG. Contact EDT.			
Type (Flash, EEPROM, etc): NOR Flash: Cypress AM29LV081B-70ED	Size: 8Mbit	User Modifiable: ☑ Yes ☐ No	Function: Configuration memory: stores "PCI FPGA" configuration bitfiles	Steps to clear memory: EDT's pciload program. Contact EDT.			
Mass Storage							
Does the device contain mass storage memory (Hard Disk Drive, Tape Backup)? Yes No If yes, describe the type, size, function, and steps to clear the memory below							
Type (HDD, Tape, etc):	Size:	User Modifiable: Yes No	Function:	Steps to clear memory:			

	USB					
	so, for what purpose (i.e. Print Jobs, device					
Yes V No If yes, describe the type	e, size, function, and steps to clear the me	emory below				
Can any data other than scan upload be						
Yes √ No If yes, describe the type	s, size, function, and steps to clear the me	emory below				
	RF/RFID					
	ve or transmit of any data including remo		Bluetooth)?			
	s, size, function, and steps to clear the me	emory below				
Purpose:	ID I M					
	requency: Bandwidth:					
Modulation:	Effective Radiate Power (E	RP):				
Specifications:						
	Other Transmission Cap	aphilities				
Does the device employ any other meth	ods of non-wired access to transmit or re		vthing.			
other than standard hard wired TCP/IP,			If yes, describe below			
other than standard hard whed 101/11;	uncer COD, or paramer connections):	Tes VINO	ii yes, acsoribe below			
Frequency:		Bandwidth:				
Modulation:		Effective Radiate Power (ERP):				
Specifications:						
г						
	Other Capabilitie					
	od of communications such as a Modem	to transmit or receive any data wha	tsoever?			
Yes No If yes, describe below:						
	or transmit serial or parallel digital data ad	cross using the LVDS or RS422 sign	naling standards, DMA'ing			
to and/or from the host computer.						
Specifications: With one	e DMA channel: up to 210 Mbytes/s. Sixte	een DMA channels: up to 70Mbits/s/	channel.			
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	Author Information	on				
Name	Title	Email	Department			
Sebastian Bonafede	HW Engineering manager		Engineering			
Date Prepared: 21-Aug-19	'	•	<u> </u>			
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